



10TH IEEE LATIN-AMERICAN CONFERENCE ON COMMUNICATIONS 14-16 NOVEMBER 2018

Guadalajara, Jalisco, México





IEEE
LATINCOM™

PRESENTATION



About LATINCOM

The IEEE Latin-American Conference on Communications (LATINCOM) is an international conference organized by the IEEE Communications Society (ComSoc) Latin America Region.

About IEEE

The IEEE (Institute of Electrical and Electronics Engineers, Inc.) is the world's largest technical professional society.

Through its more than 400,000 members in 150 countries, the organization is a leading authority on a wide variety of areas ranging from aerospace systems, computers and telecommunications to biomedical engineering, electric power and consumer electronics.

The IEEE publishes 30 percent of the world's literature in the electrical and electronics engineering and computer science fields, and has developed nearly 900 active industry standards.

About IEEE ComSoc

The IEEE ComSoc was founded in 1952 and has over 50,000 members.

It is the second largest of IEEE's 38 technical societies.

It has become the major international forum for the exchange of ideas on communications and information networking.

PRESENTATION



The IEEE LATINCOM is held annually and attracts submissions and participants from all around the world.

It covers the scope of all ComSoc Technical Committees and has a broad technical program that includes:

- Renowned keynote speakers
- Comprehensive tutorials presenting the state of the art in communications
- Presentations of original high-quality research papers selected after extensive peer-review from an open call

Its prime target is to provide a platform for researchers and practitioners in Latin America to share R&D results, to meet and to network.

PRESENTATION



This year will mark the 10th edition of the IEEE LATINCOM, and the City of Guadalajara has been chosen to host the conference for this symbolic occasion.

LATINCOM has been held in various Latin-American Countries:

- 9th **LATINCOM 2017**, in Guatemala City, Guatemala
- 8th **LATINCOM 2016**, in Medellin, Colombia
- 7th **LATINCOM 2015**, in Arequipa, Peru
- 6th **LATINCOM 2014**, in Cartagena de Indias, Colombia
- 5th **LATINCOM 2013**, in Santiago, Chile
- 4th **LATINCOM 2012**, in Cuenca, Ecuador
- 3rd **LATINCOM 2011**, in Belém, Brazil
- 2nd **LATINCOM 2010**, in Bogotá, Colombia
- 1st **LATINCOM 2009**, in Medellín, Colombia

*This will be the first time
that the conference is
organized in Mexico*

PRESENTATION



Since its first edition, LATINCOM has featured a solid technical program with participants from around the world, including:

- Renowned keynote speakers from:
 - USA,
 - Brazil,
 - Chile,
 - Colombia,
 - Peru,
 - Spain,
 - UK,
 - France,
 - Italy,
 - Denmark,
 - Ireland,
 - China
- Technical presentations by authors from more than 80 countries

TOPICS OF INTEREST



- Networking
- Wireless Communications
- Communications Services
- Optical Networks
- Enabling Technologies
- Communications Systems & Signal Processing
- Sustainable Communications & Energy Efficiency
- Communication Qos, Reliability & Performance Modeling

IMPORTANT DATES

Submission of full papers:
31 July 2018

Submission of tutorial proposals:
31 July 2018

Notification of Acceptance:
30 September 2018

Submission of camera-ready papers:
15 October 2018

EXPECTED PARTICIPATION & ORGANIZING COMMITTEE



We expect up to 250 participants, including students, technical researchers, and industry practitioners, from Latin America, the USA, Canada, Europe and other regions of the world.

The conference is jointly organized by a team comprising representatives of:

- Universidad de Guadalajara (**UDG**), Mexico
- Instituto Tecnológico y de Estudios Superiores de Occidente (**ITESO**), Mexico
- Universidad de Quintana Roo (**UQRoo**), Mexico
- Instituto Tecnológico de Sonora (**ITSON**), Mexico
- Instituto Politécnico Nacional (**IPN**), Mexico
- Universidad Autónoma de San Luis Potosí (**UASLP**), Mexico
- Universidad Autónoma Metropolitana (**UAM**), Mexico
- Universidad Panamericana (**UP**), Mexico
- National Institute of Telecommunications (INATEL), **Brazil**
- Ministerio de Tecnologías de la Información y las Comunicaciones (MinTic), **Colombia**
- Federal University of Ceará, **Brazil**
- University of British Columbia, **Canada**
- Universidad de Málaga, **Spain**
- UNICAMP, **Brazil**
- Politecnico di Milano, **Italy**

VENUE



- The conference's activities of the first will take place in the facilities of the [University of Guadalajara](#)
- The activities of the remaining two days will be held in the premises of the [Hilton Guadalajara Hotel](#)

KEYNOTE TALKS



The technical program of this year includes:

- 5 keynote talks
- 4 Tutorials
- 1 day or 1/2 day Workshops



TECHNICAL SESSIONS



The conference aims to gather researchers from around the world presenting recent advances in the telecommunications field.

- 3 blocks of technical sessions per day (6 blocks in total)
- 4 technical sessions per block (24 technical session in total)
- 4 technical/research papers per session (96 papers in total)

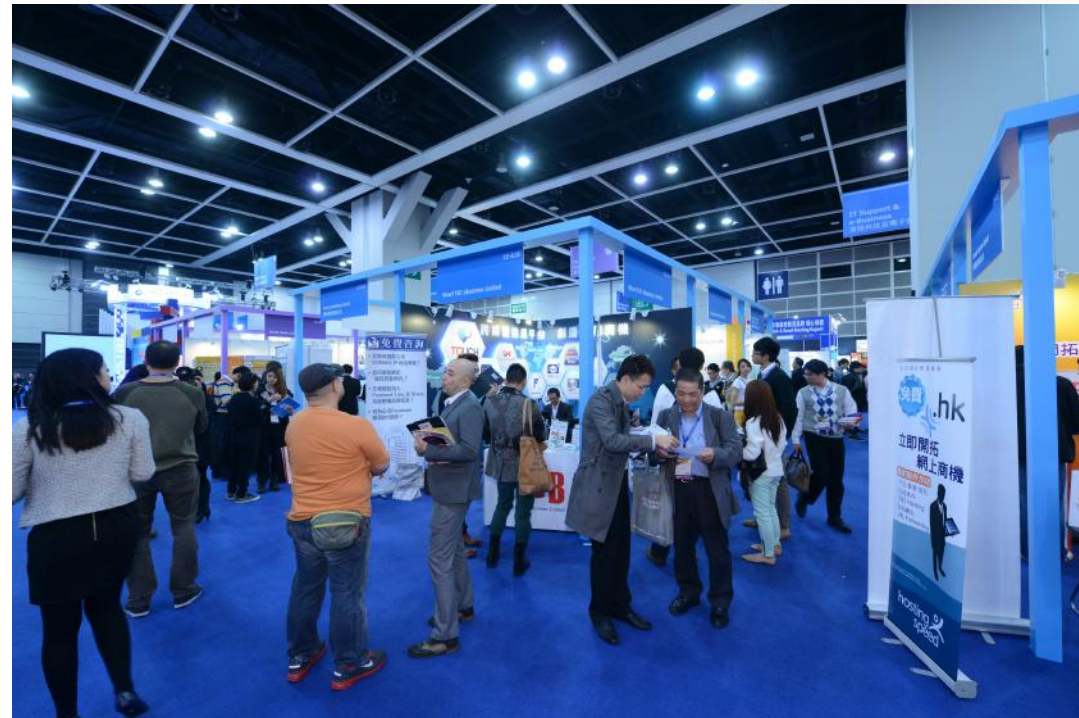


INDUSTRIAL EXHIBITION



- This year's edition will be the first to feature an industrial exhibition
- The exhibition is open to all conference attendees

Patrons will be allowed to handle exhibit passes to their clients for the announcement of new products or services



ACTIVITIES & GENERAL PROGRAM



Technical Activities

Wed, 14 Nov	Thu, 15 Nov	Fri, 16 Nov
Opening Ceremony in CUCSH-UDG	Welcome Ceremony at Hilton Hotel	
Keynote Talks	Keynote Talks	Keynote Talks
Tutorials	Technical Sessions Industrial Exhibition	Technical Sessions Industrial Exhibition

Social Activities

Wed, 14 Nov	Thu, 15 Nov	Fri, 16 Nov
Welcome Reception	Gala Dinner	Closing Ceremony

REGISTRATION FEES



Item		Early Registration Until 15 Oct (in USD)	Late Registration After 15 Oct (in USD)
Student	IEEE Member	100	150
	IEEE Non-Member	150	200
Author	Member of IEEE & COMSOC	235	285
	IEEE Member	285	335
	Non-Member of IEEE	390	440
Professional Non-Author	Member of IEEE & COMSOC	235	285
	IEEE Member	285	335
	Non-Member of IEEE	390	440
Additional Papers (fee for each additional paper up to three)		100	-
Tutorials only		50	100

PATRONAGE



We offer many levels of patronage and opportunities to exhibit.

After all EVERYONE knows that Patronage Means Leadership and Reputation.

Patronage Opportunities Include:

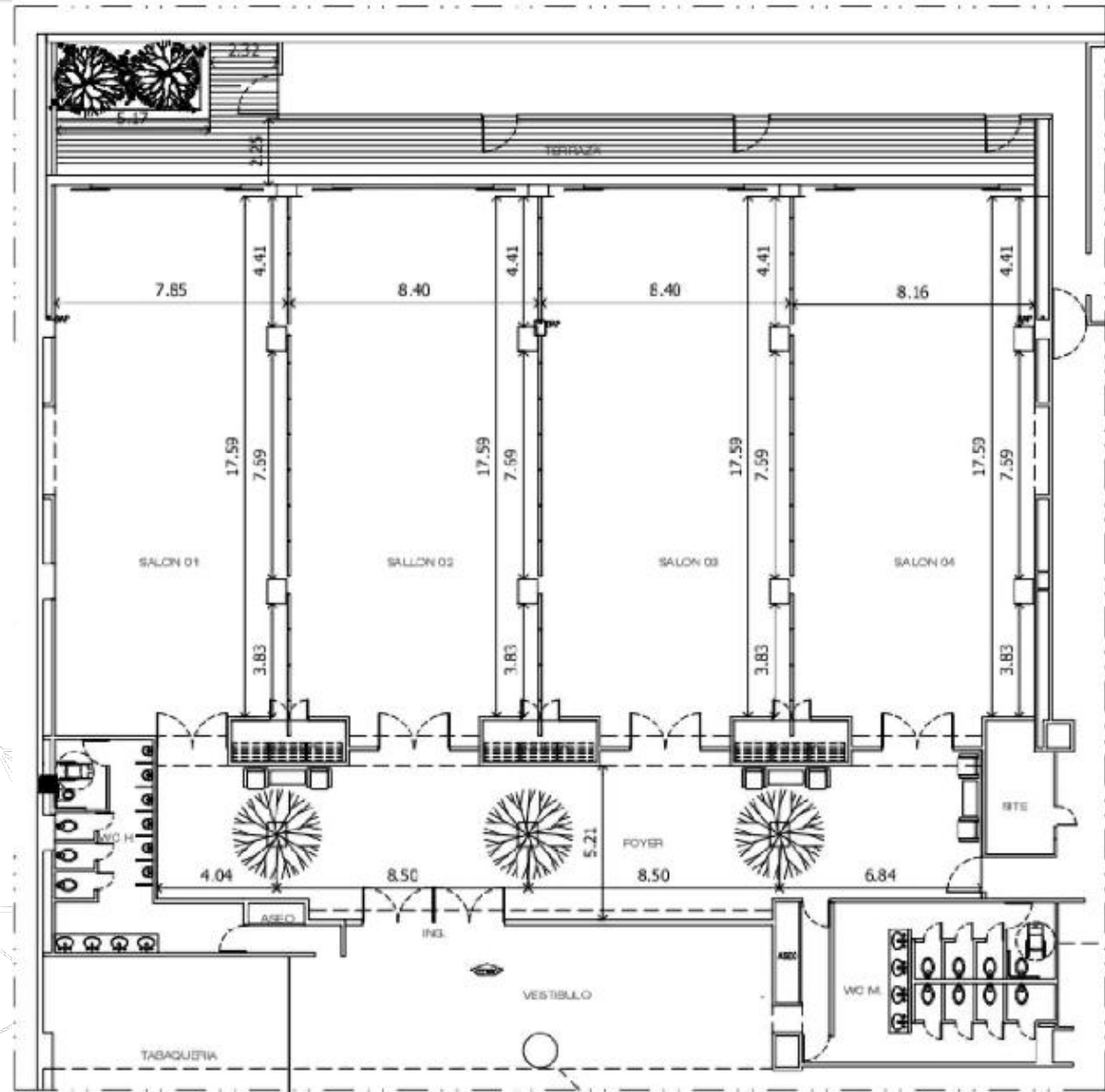
- Involvement in industry sessions and forums,
- Announcing major technology implementations,
- Addressing regulatory impact assessments,
- Defining effective economic models and discussing engineering methods used by industry practitioners.

PATRONAGE LEVELS

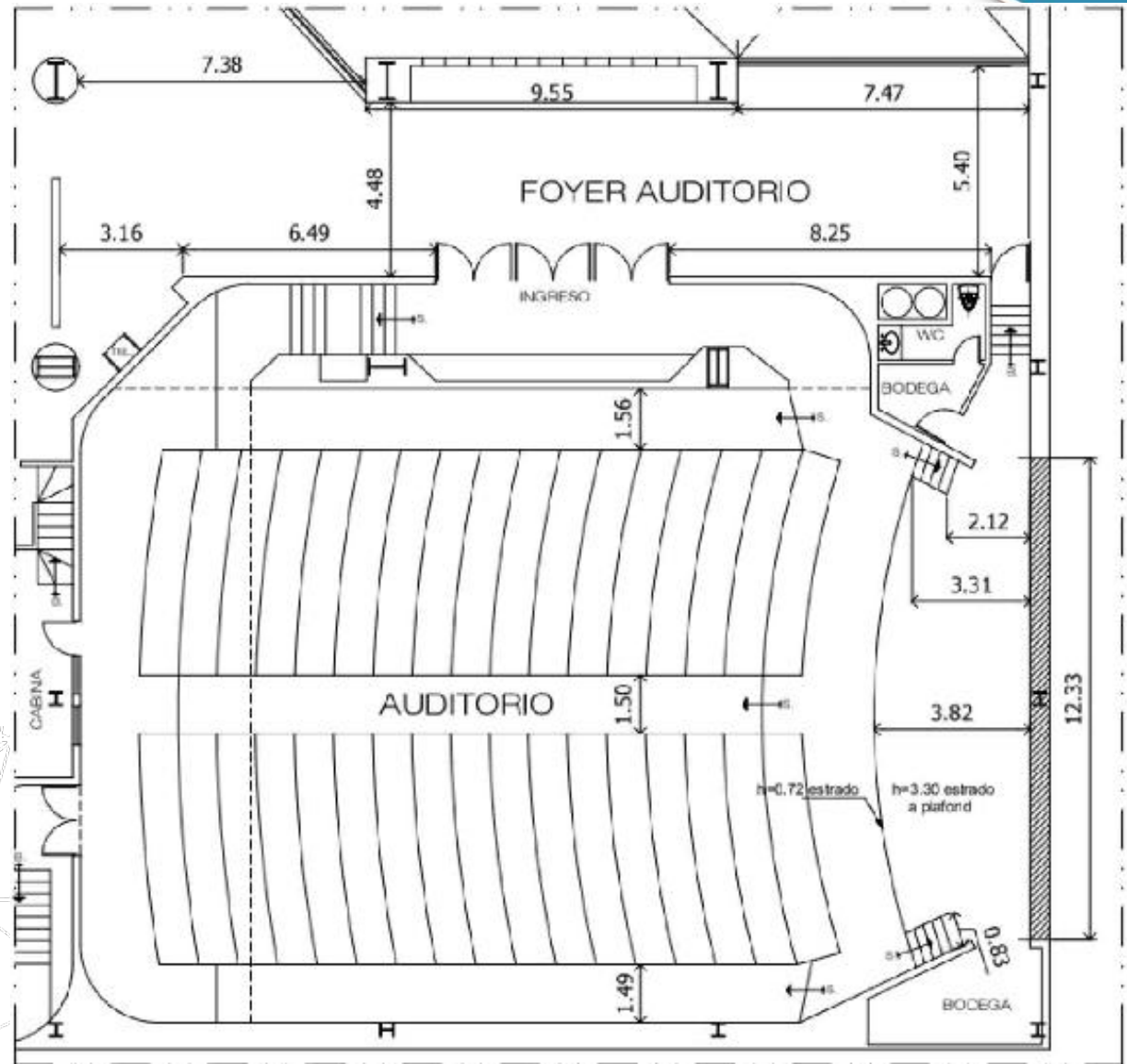


	Platinum \$4,500 USD	Gold \$3,000 USD	Silver \$1,500 USD	Bronze \$750 USD
Exhibit Space	18 m ²	9 m ²	5 m ²	3 m ²
Full Complimentary Conference Registrations	5	3	2	1
Exhibit Passes	30	15	10	5
Keynote Speaking Opportunities in the Program	Yes	No	No	No
Speaking Opportunities in the Program	Yes	Yes (Limited)	No	No
Advertisement in the Conference App	Yes	Yes	Yes	Yes
Company Logo on the Conference Web Site	Yes	Yes	Yes	Yes
Company Logo on All Conference Collateral	Yes	Yes	Yes	Yes
Company Information (e.g., Brochures) Distributed at the Conference	Yes	Yes	Yes	Yes
Media Briefing Attendance	Yes	Yes	Yes	No
Branding in Registration area and in Plenary area	Yes	No	No	No
Opportunity to host an industry related event (workshop business forum or panel discussion)	Yes	No	No	No
Gift opportunities (Meal events, etc.,)	Yes	Yes	Yes	Yes

PATRONAGE LEVELS



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Additional Support Opportunities

Opportunities (at cost) available according to the level of Patronage:

- Backpacks for attendees
- Providing lunch to attendees, Wednesday thru Friday
- Providing support for the Welcoming Reception
- Providing support for the Gala Dinner
- Providing the Coffee Breaks
- Providing Wireless Internet



For more information visit:
<http://ieeecomsoc-latincom.org/>